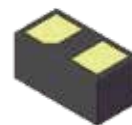


FEATURES

- | 50W Peak Pulse Power per Line (tp=8/20μs)
- | Protects one Bidirectional I/O lines
- | Working voltages : 18V
- | Low clamping voltage

APPLICATIONS

- | RS-232, RS-422, V.90 interfaces
- | WAN equipment :
 - CSU/DSU
 - Multiplexers
 - Routers
 - ISP equipment
 - Customer premise equipment
- | Microprocessor-based equipment



DFN0603



Marking



Schematic Symbol

IEC COMPATIBILITY

- | IEC61000-4-2 (ESD) ±15kV (air), ±10kV (contact)
- | IEC61000-4-4 (EFT) 40A (5/50ns)

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

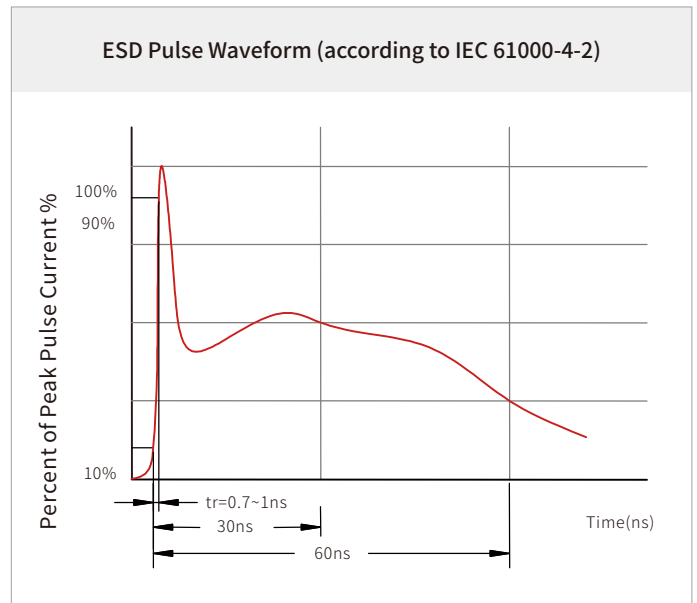
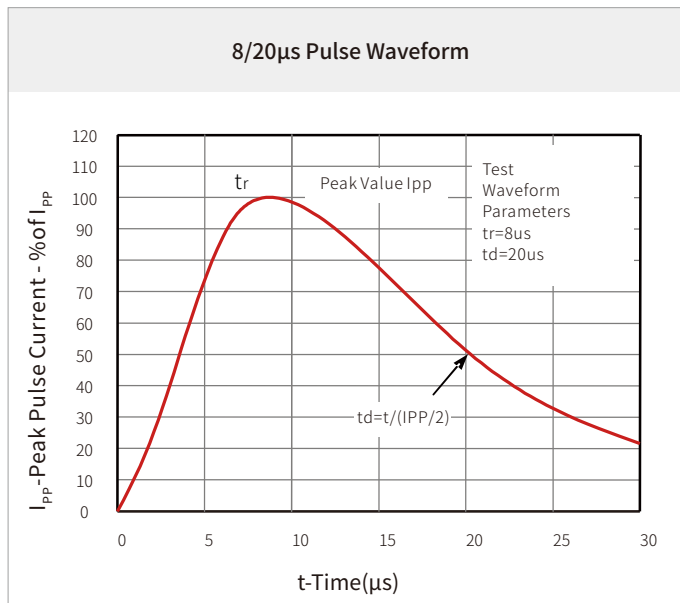
THERMAL CONSIDERATIONS

Symbol	Parameter	Value	Unit
P_{PP}	Peak Pulse Power (tp=8/20μs waveform)	50	Watts
T_J	Operating Temperature Range	-55 to +125	°C
T_{STG}	Storage Temperature Range	-55 to +150	°C

ELECTRICAL CHARACTERISTICS

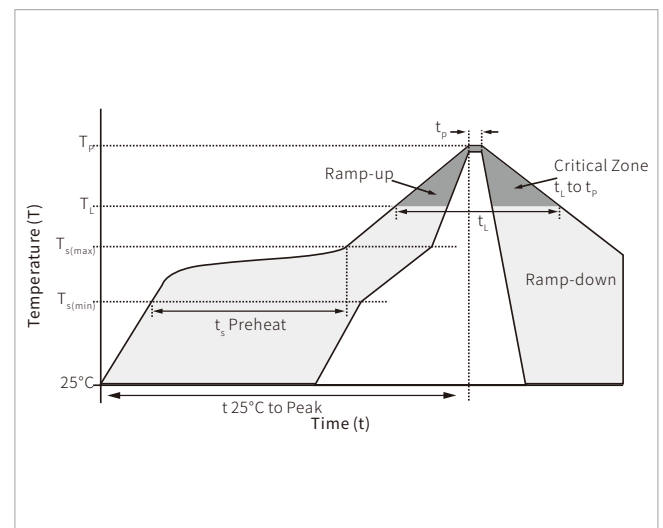
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{RWM}	Reverse Stand-off Voltage				18	V
V_{BR}	Reverse Breakdown Voltage	$I_T=1mA$	21			V
I_R	Reverse Leakage Current	$V_{RWM}=18V$			1	μA
V_C	Clamping Voltage	$I_{PP}=1A, tp=8/20\mu s$			50	V
I_{PP}	Peak Pulse Current	tp=8/20μs			1	A
C_J	Off State Junction Capacitance	$V_R=0V, f=1MHz$		2.5		pF

CHARACTERISTIC CURVES

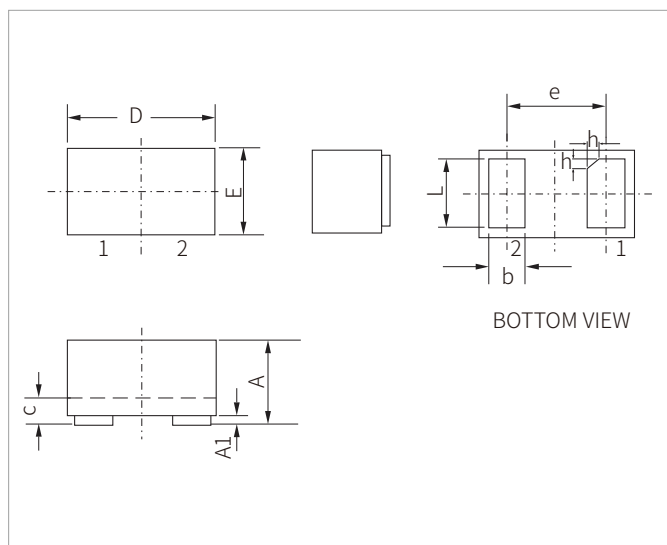


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

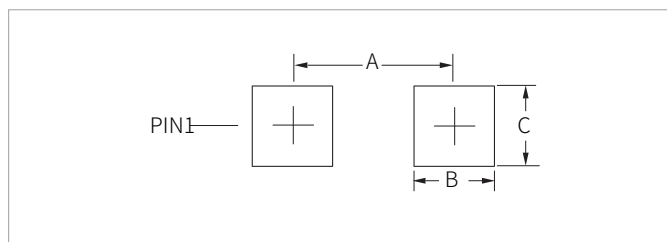


DFN0603 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.28	0.36	0.011	0.014
A1	0	0.05	0	0.002
b	0.13	0.24	0.005	0.009
c	0.05	0.15	0.002	0.006
D	0.55	0.70	0.022	0.028
e	0.35BSC		0.014BSC	
E	0.25	0.35	0.010	0.014
L	0.20	0.30	0.008	0.012
h	0	0.10	0	0.004

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
A	0.38	0.015
B	0.23	0.009
C	0.30	0.012

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SE06F10B18LA	DFN0603	10000PCS	7"

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By QR Code

Website



Wechat

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